

Dual-Channel, Digital Isolators, Enhanced System-Level ESD Reliability

FEATURES

- ▶ Enhanced system-level ESD performance per IEC 61000-4-x
- ▶ High temperature operation: 125°C
- ▶ **Narrow body, RoHS-compliant, 8-lead SOIC**
- ▶ Low power operation
 - ▶ 5 V operation
 - ▶ 1.7 mA per channel maximum at 0 Mbps to 2 Mbps
 - ▶ 3.7 mA per channel maximum at 10 Mbps
 - ▶ 7.0 mA per channel maximum at 25 Mbps
 - ▶ 3.3 V operation
 - ▶ 1.5 mA per channel maximum at 0 Mbps to 2 Mbps
 - ▶ 2.5 mA per channel maximum at 10 Mbps
 - ▶ 5.2 mA per channel maximum at 25 Mbps
- ▶ Bidirectional communication
- ▶ 3.3 V/5 V level translation
- ▶ High data rate: dc to 25 Mbps (NRZ)
- ▶ Precise timing characteristics
 - ▶ 3 ns maximum pulse width distortion
 - ▶ 3 ns maximum channel-to-channel matching
- ▶ High common-mode transient immunity: >25 kV/μs
- ▶ **Safety and regulatory approvals**
 - ▶ UL 1577
 - ▶ $V_{ISO} = 2500 V_{RMS}$ for 1 minute
 - ▶ IEC/EN/CSA 62368-1
 - ▶ IEC/CSA 61010-1
 - ▶ CQC GB4943.1
 - ▶ DIN EN IEC 60747-17 (VDE 0884-17)
 - ▶ $V_{IORM} = 560 V_{PEAK}$
- ▶ Qualified for automotive applications

APPLICATIONS

- ▶ Size-critical multichannel isolation
- ▶ SPI interface/data converter isolation
- ▶ RS-232/RS-422/RS-485 transceiver isolation
- ▶ Digital field bus isolation
- ▶ Hybrid electric vehicles, battery monitor

GENERAL DESCRIPTION

The ADuM3200/ADuM3201¹ are dual-channel, digital isolators based on the Analog Devices, Inc., iCoupler® technology. Combining high speed CMOS and monolithic transformer technology, these isolation components provide outstanding performance characteristics superior to alternatives such as optocoupler devices.

By avoiding the use of LEDs and photodiodes, iCoupler devices remove the design difficulties commonly associated with optocouplers. The typical optocoupler concerns regarding uncertain current transfer ratios, nonlinear transfer functions, and temperature and lifetime effects are eliminated with the simple iCoupler digital interfaces and stable performance characteristics. The need for external drivers and other discrete components is eliminated with these iCoupler products. Furthermore, iCoupler devices consume one-tenth to one-sixth the power of optocouplers at comparable signal data rates.

The ADuM3200/ADuM3201 isolators provide two independent isolation channels in a variety of channel configurations and data rates (see the [Ordering Guide](#)). They operate with 3.3 V or 5 V supply voltages on either side, providing compatibility with lower voltage systems as well as enabling voltage translation functionality across the isolation barrier. The ADuM3200W and ADuM3201W are automotive grade versions qualified for 125°C operation.

In comparison to the ADuM3200/ADuM3201 isolators, the ADuM3200/ADuM3201 isolators contain various circuit and layout changes to provide increased capability relative to system-level IEC 61000-4-x testing (ESD, burst, and surge). The precise capability in these tests for either the ADuM3200/ADuM3201 or ADuM3200/ADuM3201 products is strongly determined by the design and layout of the user board or module. For more information, see the [AN-793 Application Note](#), *ESD/Latch-Up Considerations with iCoupler Isolation Products*.

¹ Protected by U.S. Patents 5,952,849; 6,873,065; 7,075,329.

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REVISION HISTORY**3/2025—Rev. F to Rev. G**

Changes to Features Section.....	1
Changes to Regulatory Information Section and Table 26.....	13
Changes to Table 27.....	13
Changed DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics Section to DIN EN IEC 60747-17 (VDE 0884-17) Insulation Characteristics Section.....	14
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Changes to DC Correctness and Magnetic Field Immunity Section.....	20
Changes to Insulation Lifetime Section.....	21
Deleted Figure 15 to Figure 17.....	21
Added Number of Inputs, Maximum Data Rate, Maximum Propagation Delay, and Maximum Pulse Width Distortion Options.....	23

FUNCTIONAL BLOCK DIAGRAMS

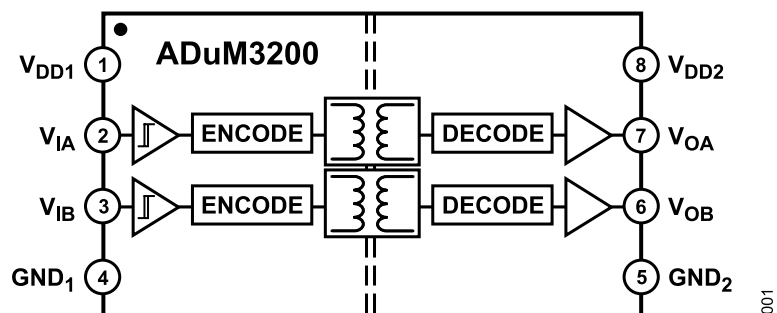


Figure 1. ADuM3200 Functional Block Diagram

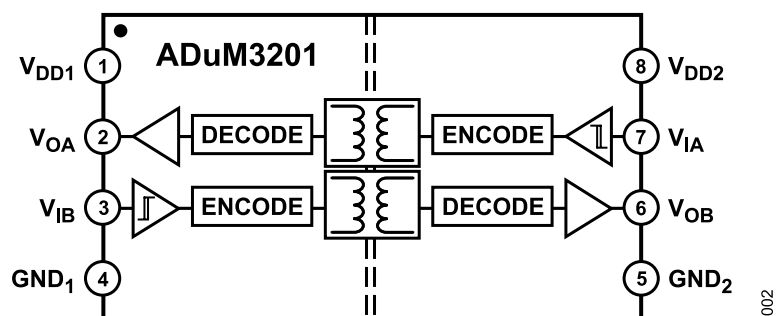


Figure 2. ADuM3201 Functional Block Diagram

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V, 105°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 1.

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t _{PHL} , t _{PLH}	20		150	20		50	20		45	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3			3	ns	t _{PLH} - t _{PHL}
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t _{PSK}			100			15			15	ns	Between any two units
Channel Matching												
Codirectional	t _{PSKCD}			50			3			3	ns	
Opposing-Direction	t _{PSKOD}			50			15			15	ns	
Output Rise/Fall Time	t _R /t _F		10			2.5			2.5		ns	10% to 90%

Table 2.

		1 Mbps—A Grade, B Grade, and C Grade			10 Mbps—B Grade and C Grade			25 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY CURRENT												
ADuM3200	I _{DD1}		1.3	1.8		3.5	4.6		7.7	10.0	mA	No load
	I _{DD2}		1.0	1.6		2.0	2.8		3.8	4.9	mA	No load
ADuM3201	I _{DD1}		1.1	1.6		3.1	4.2		6.9	8.9	mA	No load
	I _{DD2}		1.3	1.9		3.1	4.0		6.1	8.3	mA	No load

Table 3. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{\text{DDX}}$			V	
Logic Low Input Threshold	V_{IL}	$0.3 V_{\text{DDX}}$			V	
Logic High Output Voltages	V_{OH}	$V_{\text{DDX}} - 0.1$	V_{DDX}		V	$I_{\text{OX}} = -20\text{ }\mu\text{A}$, $V_{\text{IX}} = V_{\text{IXH}}$
		$V_{\text{DDX}} - 0.5$	$V_{\text{DDX}} - 0.2$		V	$I_{\text{OX}} = -3.2\text{ mA}$, $V_{\text{IX}} = V_{\text{IXH}}$
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	$I_{\text{OX}} = 20\text{ }\mu\text{A}$, $V_{\text{IX}} = V_{\text{IXL}}$
			0.2	0.4	V	$I_{\text{OX}} = 3.2\text{ mA}$, $V_{\text{IX}} = V_{\text{IXL}}$
Input Current per Channel	I_{I}	-10	+0.01	+10	μA	$0\text{ V} \leq V_{\text{IX}} \leq V_{\text{DDX}}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{\text{DDI(Q)}}$		0.4	0.8	mA	$V_{\text{IA}} = V_{\text{IB}} = 0\text{ V}$
Quiescent Output Supply Current	$I_{\text{DDO(Q)}}$		0.5	0.6	mA	$V_{\text{IA}} = V_{\text{IB}} = 0\text{ V}$
Dynamic Input Supply Current	$I_{\text{DDI(D)}}$		0.19		mA/Mbps	
Dynamic Output Supply Current	$I_{\text{DDO(D)}}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μs	$V_{\text{IX}} = V_{\text{DDX}}$, $V_{\text{CM}} = 1000\text{ V}$, transient magnitude = 800 V
Refresh Rate	f_{r}		1.2		Mbps	

SPECIFICATIONS

¹ |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—3.3 V, 105°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 3.3\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$, $3.0\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 4.

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	20		150	20		60	20		55	ns	50% input to 50% output
Pulse Width Distortion	PWD											
ADuM3200				40			3			3	ns	$ t_{PLH} - t_{PHL} $
ADuM3201				40			4			4	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			100			22			16	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			3	ns	
Opposing-Direction	t_{PSKOD}			50			22			16	ns	
Output Rise/Fall Time	t_R/t_F		3.0			3.0			3.0		ns	10% to 90%

Table 5.

		1 Mbps—A Grade, B Grade, and C Grade			10 Mbps—B Grade and C Grade			25 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY CURRENT												
ADuM3200	I _{DD1}		0.8	1.3		2.2	3.2		4.8	6.4	mA	No load
	I _{DD2}		0.7	1.0		1.3	1.7		2.3	3.0	mA	No load
ADuM3201	I _{DD1}		0.7	1.3		1.9	2.5		4.1	5.3	mA	No load
	I _{DD2}		0.8	1.6		1.9	2.5		3.7	5.1	mA	No load

Table 6. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{DDX}$			V	
Logic Low Input Threshold	V_{IL}	$0.3 V_{DDX}$			V	
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$	V_{DDX}		V	$I_{OX} = -20\text{ }\mu\text{A}$, $V_{IX} = V_{IXH}$
		$V_{DDX} - 0.5$	$V_{DDX} - 0.2$		V	$I_{OX} = -3.2\text{ mA}$, $V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}	0.0		0.1	V	$I_{OX} = 20\text{ }\mu\text{A}$, $V_{IX} = V_{IXL}$
		0.2		0.4	V	$I_{OX} = 3.2\text{ mA}$, $V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0\text{ V} \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DD(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0\text{ V}$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0\text{ V}$
Dynamic Input Supply Current	$I_{DD(P)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(P)}$		0.03		mA/Mbps	

SPECIFICATIONS

Table 6. For All Models (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	CM	25	35		kV/μs	$V_{IX} = V_{DDX}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
Refresh Rate	f_r		1.1		Mbps	

¹ |CM| is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 5 V/3.3 V, 105°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = 5$ V, $V_{DD2} = 3.3$ V. Minimum/maximum specifications apply over the entire recommended operation range: $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, $3.0\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15$ pF, and CMOS signal levels, unless otherwise noted.

Table 7.

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t _{PHL} , t _{PLH}	15		150	15		55	15		50	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3			3	ns	t _{PLH} - t _{PHL}
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t _{PSK}			50			22			15	ns	Between any two units
Channel Matching												
Codirectional	t _{PSKCD}			50			3			3	ns	
Opposing-Direction	t _{PSKOD}			50			22			15	ns	
Output Rise/Fall Time	t _R /t _F		3.0			3.0			3.0		ns	10% to 90%

Table 8.

		1 Mbps—A Grade, B Grade, and C Grade			10 Mbps—B Grade and C Grade			25 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY CURRENT												
ADuM3200	I _{DD1}		1.3	1.8		3.5	4.6		7.7	10.0	mA	No load
	I _{DD2}		0.7	1.0		1.3	1.7		2.3	3.0	mA	No load
ADuM3201	I _{DD1}		1.1	1.6		3.1	4.2		6.9	8.9	mA	No load
	I _{DD2}		0.8	1.6		1.9	2.5		3.7	5.1	mA	No load

Table 9. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{DDX}$			V	
Logic Low Input Threshold	V_{IL}			$0.3 V_{DDX}$	V	
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$	V_{DDX}		V	$I_{OX} = -20\text{ }\mu\text{A}$, $V_{IX} = V_{IXH}$
		$V_{DDX} - 0.5$	$V_{DDX} - 0.2$		V	$I_{OX} = -3.2\text{ mA}$, $V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	$I_{OX} = 20\text{ }\mu\text{A}$, $V_{IX} = V_{IXL}$
			0.2	0.4	V	$I_{OX} = 3.2\text{ mA}$, $V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0\text{ V} \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						

SPECIFICATIONS

Table 9. For All Models (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.4	0.8	mA	$V_{IA} = V_{IB} = 0\text{ V}$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0\text{ V}$
Dynamic Input Supply Current	$I_{DDI(P)}$		0.19		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(P)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μ s	$V_{IX} = V_{DDX}$, $V_{CM} = 1000\text{ V}$, transient magnitude = 800 V
Refresh Rate	f_r		1.2		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 3.3 V/5 V, 105°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = 3.3\text{ V}$, $V_{DD2} = 5.0\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$, $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 10.

Table 10-1												
Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL}, t_{PLH}	15		150	15		55	15		50	ns	50% input to 50% output
Pulse Width Distortion	PWD											
ADuM3200				40			3			3	ns	$ t_{PLH} - t_{PHL} $
ADuM3201				40			4			4	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			15	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			3	ns	
Opposing-Direction	t_{PSKOD}			50			22			15	ns	
Output Rise/Fall Time	t_R/t_F		2.5			2.5			2.5		ns	10% to 90%

Table 11.

		1 Mbps—A Grade, B Grade, and C Grade			10 Mbps—B Grade and C Grade			25 Mbps—C Grade				
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY CURRENT												
ADuM3200	I _{DD1}		0.8	1.3		2.2	3.2		4.8	6.4	mA	No load
	I _{DD2}		1.0	1.6		2.0	2.8		3.8	4.9	mA	No load
ADuM3201	I _{DD1}		0.7	1.3		1.9	2.5		4.1	5.3	mA	No load
	I _{DD2}		1.3	1.9		3.1	4.0		6.1	8.3	mA	No load

Table 12. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{DDX}$			V	
Logic Low Input Threshold	V_{IL}			$0.3 V_{DDX}$	V	

SPECIFICATIONS

Table 12. For All Models (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$ $V_{DDX} - 0.5$	V_{DDX} $V_{DDX} - 0.2$		V V	$I_{OX} = -20 \mu A$, $V_{IX} = V_{IXH}$ $I_{OX} = -3.2 \text{ mA}$, $V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}		0.0 0.2	0.1 0.4	V V	$I_{OX} = 20 \mu A$, $V_{IX} = V_{IXL}$ $I_{OX} = 3.2 \text{ mA}$, $V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0 \text{ V} \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.5	0.6	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Dynamic Input Supply Current	$I_{DDI(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μs	$V_{IX} = V_{DDX}$, $V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V
Refresh Rate	f_r		1.1		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—5 V, 125°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 5 \text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $4.5 \text{ V} \leq V_{DD1} \leq 5.5 \text{ V}$, $4.5 \text{ V} \leq V_{DD2} \leq 5.5 \text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15 \text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 13.

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t _{PHL} , t _{PLH}	20		150	20		50	20		45	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3			3	ns	t _{PLH} - t _{PHL}
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t _{PSK}			100			15			15	ns	Between any two units
Channel Matching												
Codirectional	t _{PSKCD}			50			3			3	ns	
Opposing-Direction	t _{PSKOD}			50			15			15	ns	
Output Rise/Fall Time	t _R /t _F		2.5			2.5			2.5		ns	10% to 90%

Table 14.

		1 Mbps—WA Grade, WB Grade, and WC Grade			10 Mbps—WB Grade and WC Grade			25 Mbps—WC Grade			Test Conditions/ Comments	
Parameter	Symbol	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	
SUPPLY CURRENT												
ADuM3200	I _{DD1}		1.3	2.0		3.5	4.6		7.7	10.0	mA	No load
	I _{DD2}		1.0	1.6		1.7	2.8		3.1	3.9	mA	No load
ADuM3201	I _{DD1}		1.1	1.5		2.6	3.4		5.3	6.8	mA	No load
	I _{DD2}		1.3	1.8		3.1	4.0		6.4	8.3	mA	No load

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Table 15. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{DDX}$			V	
Logic Low Input Threshold	V_{IL}			$0.3 V_{DDX}$	V	
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$	V_{DDX}		V	$I_{OX} = -20 \mu A, V_{IX} = V_{IXH}$
		$V_{DDX} - 0.5$	$V_{DDX} - 0.2$		V	$I_{OX} = -3.2 mA, V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	$I_{OX} = 20 \mu A, V_{IX} = V_{IXL}$
			0.2	0.4	V	$I_{OX} = 3.2 mA, V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0 V \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.4	0.8	mA	$V_{IA} = V_{IB} = 0 V$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.5	0.6	mA	$V_{IA} = V_{IB} = 0 V$
Dynamic Input Supply Current	$I_{DDI(D)}$		0.19		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μs	$V_{IX} = V_{DDX}, V_{CM} = 1000 V$, transient magnitude = 800 V
Refresh Rate	f_r		1.2		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—3.3 V, 125°C OPERATION

All typical specifications are at $T_A = 25^\circ C$, $V_{DD1} = V_{DD2} = 3.3 V$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0 V \leq V_{DD1} \leq 3.6 V$, $3.0 V \leq V_{DD2} \leq 3.6 V$, and $-40^\circ C \leq T_A \leq +125^\circ C$, unless otherwise noted. Switching specifications are tested with $C_L = 15 pF$ and CMOS signal levels, unless otherwise noted.

Table 16.

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t _{PHL} , t _{PLH}	20		150	20		60	20		55	ns	50% input to 50% output
Pulse Width Distortion	PWD											
ADuM3200				40			3			3	ns	t _{PLH} - t _{PHL}
ADuM3201				40			4			4	ns	t _{PLH} - t _{PHL}
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t _{PSK}			100			22			16	ns	Between any two units
Channel Matching												
Codirectional	t _{PSKCD}			50			3			3	ns	
Opposing-Direction	t _{PSKOD}			50			22			16	ns	
Output Rise/Fall Time	t _R /t _F		3.0			3.0			3.0		ns	10% to 90%

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Table 17.

Parameter	Symbol	1 Mbps—WA Grade, WB Grade, and WC Grade			10 Mbps—WB Grade and WC Grade			25 Mbps—WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM3200	I_{DD1}		0.8	1.3		2.0	3.2		4.3	6.4	mA	No load
	I_{DD2}		0.7	1.0		1.1	1.7		1.8	2.4	mA	No load
ADuM3201	I_{DD1}		0.7	1.3		1.5	2.1		3.0	4.2	mA	No load
	I_{DD2}		0.8	1.6		1.9	2.4		3.6	5.1	mA	No load

Table 18. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	$0.7 V_{DDX}$			V	
Logic Low Input Threshold	V_{IL}	$0.3 V_{DDX}$			V	
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$	V_{DDX}		V	$I_{OX} = -20 \mu A$, $V_{IX} = V_{IXH}$
		$V_{DDX} - 0.5$	$V_{DDX} - 0.2$		V	$I_{OX} = -3.2 \text{ mA}$, $V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}		0.0	0.1	V	$I_{OX} = 20 \mu A$, $V_{IX} = V_{IXL}$
			0.2	0.4	V	$I_{OX} = 3.2 \text{ mA}$, $V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0 \text{ V} \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Dynamic Input Supply Current	$I_{DDI(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μs	$V_{IX} = V_{DDX}$, $V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V
Refresh Rate	f_r		1.1		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 5 V/3.3 V, 125°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = 5 \text{ V}$, $V_{DD2} = 3.3 \text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $4.5 \text{ V} \leq V_{DD1} \leq 5.5 \text{ V}$, $3.0 \text{ V} \leq V_{DD2} \leq 3.6 \text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15 \text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 19.

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			25	Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	15		150	15		55	15		50	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3			3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			15	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			3	ns	

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Table 19. (Continued)

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
Opposing-Direction Output Rise/Fall Time	t_{PSKOD} t_R/t_F			50			22			15	ns	
			3.0			3.0			3.0		ns	10% to 90%

Table 20.

Parameter	Symbol	1 Mbps—WA Grade, WB Grade, and WC Grade			10 Mbps—WB Grade and WC Grade			25 Mbps—WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM3200	I_{DD1}		1.3	2.0		3.5	4.6		7.7	10.0	mA	No load
	I_{DD2}		0.7	1.0		1.1	1.7		1.8	2.4	mA	No load
ADuM3201	I_{DD1}		1.1	1.5		2.6	3.4		5.3	6.8	mA	No load
	I_{DD2}		0.8	1.6		1.9	2.4		3.6	5.1	mA	No load

Table 21. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V_{IH}	0.7 V_{DDX}			V	
Logic Low Input Threshold	V_{IL}			0.3 V_{DDX}	V	
Logic High Output Voltages	V_{OH}	$V_{DDX} - 0.1$ $V_{DDX} - 0.5$	V_{DDX} $V_{DDX} - 0.2$		V	$I_{OX} = -20 \mu A$, $V_{IX} = V_{IXH}$ $I_{OX} = -3.2 \text{ mA}$, $V_{IX} = V_{IXH}$
Logic Low Output Voltages	V_{OL}		0.0 0.2	0.1 0.4	V	$I_{OX} = 20 \mu A$, $V_{IX} = V_{IXL}$ $I_{OX} = 3.2 \text{ mA}$, $V_{IX} = V_{IXL}$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0 \text{ V} \leq V_{IX} \leq V_{DDX}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.4	0.8	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.3	0.5	mA	$V_{IA} = V_{IB} = 0 \text{ V}$
Dynamic Input Supply Current	$I_{DDI(D)}$		0.19		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	$ CM $	25	35		kV/ μs	$V_{IX} = V_{DDX}$, $V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V
Refresh Rate	f_r		1.2		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

ELECTRICAL CHARACTERISTICS—MIXED 3.3 V/5 V, 125°C OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = 3.3 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0 \text{ V} \leq V_{DD1} \leq 3.6 \text{ V}$, $4.5 \text{ V} \leq V_{DD2} \leq 5.5 \text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15 \text{ pF}$ and CMOS signal levels, unless otherwise noted.

Table 22.

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate			1			10			25		Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	15	150		15	55		15	50		ns	50% input to 50% output

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Table 22. (Continued)

Parameter	Symbol	WA Grade			WB Grade			WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
Pulse Width Distortion	PWD											
ADuM3200				40			3			3	ns	$ t_{PLH} - t_{PHL} $
ADuM3201				40			4			4	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			6			5			5		ps/°C	
Pulse Width	PW	1000			100			40			ns	Within PWD limit
Propagation Delay Skew	t_{PSK}			50			22			15	ns	Between any two units
Channel Matching												
Codirectional	t_{PSKCD}			50			3			3	ns	
Opposing-Direction	t_{PSKOD}			50			22			15	ns	
Output Rise/Fall Time	t_R/t_F		2.5			2.5			2.5		ns	10% to 90%

Table 23.

Parameter	Symbol	1 Mbps—WA Grade, WB Grade, and WC Grade			10 Mbps—WB Grade and WC Grade			25 Mbps—WC Grade			Unit	Test Conditions/Comments
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM3200	I_{DD1}		0.8	1.3		2.0	3.2		4.3	6.4	mA	No load
	I_{DD2}		1.0	1.6		1.7	2.8		3.1	3.9	mA	No load
ADuM3201	I_{DD1}		0.7	1.3		1.5	2.1		3.0	4.2	mA	No load
	I_{DD2}		1.3	1.8		3.1	4.0		6.4	8.3	mA	No load

Table 24. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DC SPECIFICATIONS						
Logic High Input Threshold	V _{IH}	0.7 V _{DDx}			V	I _{Ox} = -20 μA, V _{Ix} = V _{IxH} I _{Ox} = -3.2 mA, V _{Ix} = V _{IxH} I _{Ox} = 20 μA, V _{Ix} = V _{IxL} I _{Ox} = 3.2 mA, V _{Ix} = V _{IxL}
Logic Low Input Threshold	V _{IL}	0.3 V _{DDx}			V	
Logic High Output Voltages	V _{OH}	V _{DDx} - 0.1	V _{DDx}	0.1	V	
		V _{DDx} - 0.5	V _{DDx} - 0.2		V	
Logic Low Output Voltages	V _{OL}	0.0			V	
			0.2	0.4	V	I _{Ox} = 3.2 mA, V _{Ix} = V _{IxL}
Input Current per Channel	I _I	-10	+0.01	+10	μA	0 V ≤ V _{Ix} ≤ V _{DDX}
Supply Current per Channel						
Quiescent Input Supply Current	I _{DDI(Q)}		0.3	0.5	mA	V _{IA} = V _{IB} = 0 V
Quiescent Output Supply Current	I _{DDO(Q)}		0.5	0.6	mA	V _{IA} = V _{IB} = 0 V
Dynamic Input Supply Current	I _{DDI(D)}		0.10		mA/Mbps	
Dynamic Output Supply Current	I _{DDO(D)}		0.05		mA/Mbps	
AC SPECIFICATIONS						
Common-Mode Transient Immunity ¹	CM	25	35		kV/μs	V _{Ix} = V _{DDX} , V _{CM} = 1000 V, transient magnitude = 800 V
Refresh Rate	f _r		1.1		Mbps	

¹ $|CM|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

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PACKAGE CHARACTERISTICS

Table 25.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Resistance (Input to Output) ¹	R_{I-O}		10^{12}		Ω	
Capacitance (Input to Output) ¹	C_{I-O}		1.0		pF	$f = 1 \text{ MHz}$
Input Capacitance	C_I		4.0		pF	
IC Junction-to-Case Thermal Resistance, Side 1	θ_{JCI}		46		$^{\circ}\text{C/W}$	Thermocouple located at center of package underside
IC Junction-to-Case Thermal Resistance, Side 2	θ_{JCO}		41		$^{\circ}\text{C/W}$	

¹ The device is considered a 2-terminal device; Pin 1, Pin 2, Pin 3, and Pin 4 are shorted together, and Pin 5, Pin 6, Pin 7, and Pin 8 are shorted together.

REGULATORY INFORMATION

The ADuM3200/ADuM3201 certification approvals are listed in Table 26. Refer to the [Insulation Lifetime](#) section for details regarding recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 26.

UL	CSA	CQC	VDE
UL 1577 ¹ Single Protection, 2500 V_{RMS}	IEC/EN/CSA 62368-1 Basic insulation, 400 V_{RMS} Reinforced insulation, 150 V_{RMS} IEC/CSA 61010-1 Basic insulation, 300 V_{RMS} Reinforced insulation, 150 V_{RMS}	CQC GB4943.1 Basic insulation, 400 V_{RMS} Reinforced insulation, 200 V_{RMS}	DIN EN IEC 60747-17 (VDE 0884-17) ² Reinforced insulation, 560 V_{PEAK}
File E214100	File No. 205078	Certificate No. CQC14001117250	Certificate No. 40011599

¹ In accordance with UL 1577, each ADuM3200/ADuM3201 is proof-tested by applying an insulation test voltage $\geq 3000 V_{RMS}$ for 1 second (current leakage detection limit = 5 μA).

² In accordance with DIN EN IEC 60747-17 (VDE 0884-17), each ADuM3200/ADuM3201 is proof-tested by applying an insulation test voltage $\geq 1050 V_{PEAK}$ for 1 second (partial discharge detection limit = 5 pC). An asterisk (*) marking branded on the component designates DIN EN IEC 60747-17 (VDE 0884-17) approval.

INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 27.

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		2500	V_{RMS}	1-minute duration
Minimum External Air Gap (Clearance) ^{1, 2}	L(I01)	4.0	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage) ¹	L(I02)	4.0	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Internal Gap (Internal Clearance)		18	μm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index) ³	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group (DIN VDE 0110, 1/89, Table 1)

¹ In accordance with IEC 62368-1/IEC 60601-1 guidelines for the measurement of creepage and clearance distances for a pollution degree of 2 and altitudes $\leq 2000 \text{ m}$.

² Consideration must be given to pad layout to ensure the minimum required distance for clearance is maintained.

³ CTI rating for the ADuM3200/ADuM3201 is >400 V and a Material Group II isolation group.

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DIN EN IEC 60747-17 (VDE 0884-17) INSULATION CHARACTERISTICS

These isolators are suitable for reinforced isolation only within the safety limit data. Maintenance of the safety data is ensured by protective circuits. The asterisk (*) marking on the package denotes DIN EN IEC 60747-17 (VDE 0884-17) approval.

Table 28.

Description	Test Conditions/Comments	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110			I to IV	
For Rated Mains Voltage $\leq 150 V_{RMS}$			I to III	
For Rated Mains Voltage $\leq 300 V_{RMS}$			I to II	
For Rated Mains Voltage $\leq 400 V_{RMS}$			40/105/21	
Climatic Classification			2	
Pollution Degree per DIN VDE 0110, Table 1				
Maximum Repetitive Isolation Voltage		V_{IORM}	560	V_{PEAK}
Maximum Working Insulation Voltage		V_{IOWM}	396	V_{RMS}
Input-to-Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{PR}$, 100% production test, $t_m = 1$ sec, partial discharge < 5 pC	V_{PR}	1050	V_{PEAK}
Input-to-Output Test Voltage, Method A	$V_{IORM} \times 1.6 = V_{PR}$, $t_m = 60$ sec, partial discharge < 5 pC	V_{PR}		
After Environmental Tests Subgroup 1			896	V_{PEAK}
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{PR}$, $t_m = 60$ sec, partial discharge < 5 pC		672	V_{PEAK}
Maximum Transient Isolation Voltage	$V_{TEST} = 1.2 \times V_{IOTM}$, $t = 1$ sec (100% production)	V_{IOTM}	4000	V_{PEAK}
Maximum Impulse Voltage	Surge voltage in air, waveform per IEC 61000-4-5	V_{IMP}	4000	V_{PEAK}
Maximum Surge Isolation Voltage	$V_{TEST} \geq 1.3 \times V_{IMP}$ (sample test), tested in oil, waveform per IEC 61000-4-5	V_{IOSM}	10,000	V_{PEAK}
Safety-Limiting Values	Maximum value allowed in the event of a failure (see Figure 3)			
Case Temperature		T_S	150	$^{\circ}C$
Side 1 Current		I_{S1}	160	mA
Side 2 Current		I_{S2}	170	mA
Insulation Resistance at T_S	$V_{IO} = 500$ V	R_S	$>10^9$	Ω

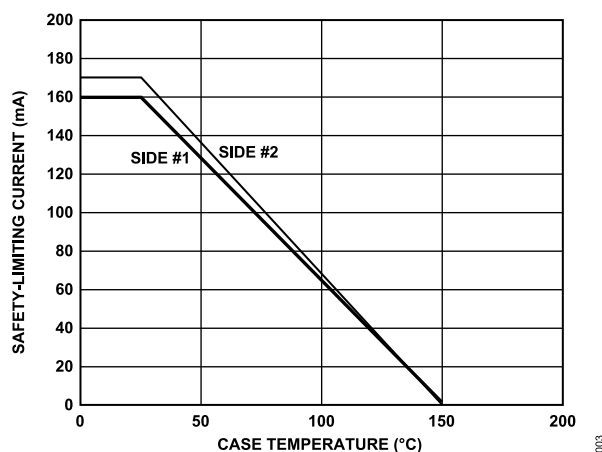


Figure 3. Thermal Derating Curve, Dependence of Safety-Limiting Values on Case Temperature, per DIN EN IEC 60747-17 (VDE 0884-17)

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RECOMMENDED OPERATING CONDITIONS

Table 29.

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_A			
ADuM3200A/ADuM3201A		-40	+105	°C
ADuM3200B/ADuM3201B		-40	+105	°C
ADuM3200C/ADuM3201C		-40	+105	°C
ADuM3200WA/ADuM3201WA		-40	+125	°C
ADuM3200WB/ADuM3201WB		-40	+125	°C
ADuM3200WC/ADuM3201WC		-40	+125	°C
Supply Voltages ¹	V_{DD1}, V_{DD2}			
ADuM3200A/ADuM3201A		3.0	5.5	V
ADuM3200B/ADuM3201B		3.0	5.5	V
ADuM3200C/ADuM3201C		3.0	5.5	V
ADuM3200WA/ADuM3201WA		3.0	5.5	V
ADuM3200WB/ADuM3201WB		3.0	5.5	V
ADuM3200WC/ADuM3201WC		3.0	5.5	V
Maximum Input Signal Rise and Fall Times			1.0	ms

¹ All voltages are relative to their respective ground. See the [DC Correctness and Magnetic Field Immunity](#) section for information on immunity to external magnetic fields.

ABSOLUTE MAXIMUM RATINGS

Ambient temperature = 25°C, unless otherwise noted.

Table 30.

Parameter	Rating
Storage Temperature (T_{ST})	-55°C to +150°C
Ambient Operating Temperature (T_A)	-40°C to +125°C
Supply Voltages (V_{DD1} , V_{DD2}) ¹	-0.5 V to +7.0 V
Input Voltage (V_{IA} , V_{IB}) ^{1, 2}	-0.5 V to $V_{DD1} + 0.5$ V
Output Voltage (V_{OA} , V_{OB}) ^{1, 2}	-0.5 V to $V_{DDO} + 0.5$ V
Average Output Current, per Pin (I_O) ³	-22 mA to +22 mA
Common-Mode Transients (CM_L , CM_H) ⁴	-100 kV/μs to +100 kV/μs

¹ All voltages are relative to their respective ground.

² V_{DD1} and V_{DDO} refer to the supply voltages on the input and output sides of a given channel, respectively.

³ See Figure 3 for maximum rated current values for various temperatures.

⁴ Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Ratings can cause latch-up or permanent damage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

ABSOLUTE MAXIMUM RATINGS

MAXIMUM CONTINUOUS WORKING VOLTAGE

Table 31. Maximum Continuous Working Voltage¹

Parameter	Max	Unit	Constraint
AC Voltage Bipolar Waveform	560	V_{PEAK}	Reinforced Insulation rating per IEC 60747-17 (VDE 0884-17)

¹ Refers to continuous voltage magnitude imposed across the isolation barrier. See the [Insulation Lifetime](#) section for more details.

TRUTH TABLES

Table 32. ADuM3200 Truth Table (Positive Logic)

V_{IA} Input	V_{IB} Input	V_{DD1} State	V_{DD2} State	V_{OA} Output	V_{OB} Output	Notes
H	H	Powered	Powered	H	H	
L	L	Powered	Powered	L	L	
H	L	Powered	Powered	H	L	
L	H	Powered	Powered	L	H	
X	X	Unpowered	Powered	H	H	Outputs return to the input state within 1 μ s of V_{DD1} power restoration.
X	X	Powered	Unpowered	Indeterminate	Indeterminate	Outputs return to the input state within 1 μ s of V_{DD0} power restoration.

Table 33. ADuM3201 Truth Table (Positive Logic)

V_{IA} Input	V_{IB} Input	V_{DD1} State	V_{DD2} State	V_{OA} Output	V_{OB} Output	Notes
H	H	Powered	Powered	H	H	
L	L	Powered	Powered	L	L	
H	L	Powered	Powered	H	L	
L	H	Powered	Powered	L	H	
X	X	Unpowered	Powered	Indeterminate	H	Outputs return to the input state within 1 μ s of V_{DD1} power restoration.
X	X	Powered	Unpowered	H	Indeterminate	Outputs return to the input state within 1 μ s of V_{DD0} power restoration.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

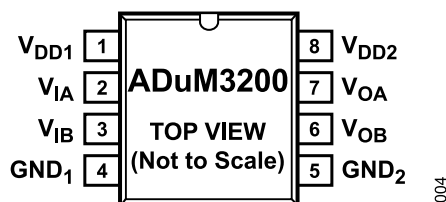


Figure 4. ADuM3200 Pin Configuration

Table 34. ADuM3200 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{DD1}	Supply Voltage for Isolator Side 1.
2	V _{IA}	Logic Input A.
3	V _{IB}	Logic Input B.
4	GND ₁	Ground 1. Ground reference for Isolator Side 1.
5	GND ₂	Ground 2. Ground reference for Isolator Side 2.
6	V _{OB}	Logic Output B.
7	V _{OA}	Logic Output A.
8	V _{DD2}	Supply Voltage for Isolator Side 2.

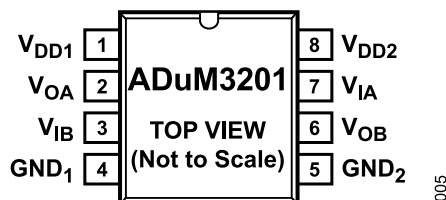


Figure 5. ADuM3201 Pin Configuration

Table 35. ADuM3201 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{DD1}	Supply Voltage for Isolator Side 1.
2	V _{OA}	Logic Output A.
3	V _{IB}	Logic Input B.
4	GND ₁	Ground 1. Ground reference for Isolator Side 1.
5	GND ₂	Ground 2. Ground reference for Isolator Side 2.
6	V _{OB}	Logic Output B.
7	V _{IA}	Logic Input A.
8	V _{DD2}	Supply Voltage for Isolator Side 2.

TYPICAL PERFORMANCE CHARACTERISTICS

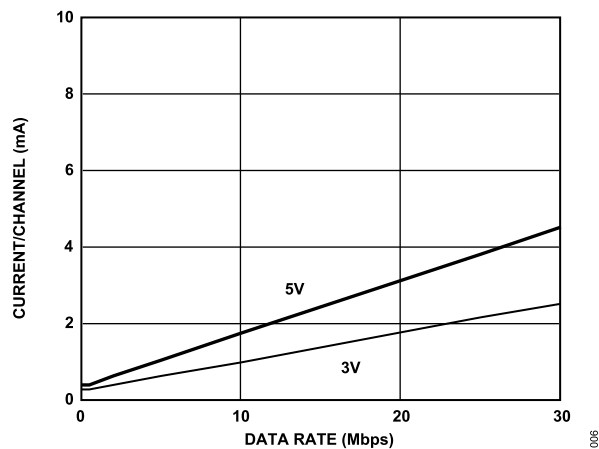


Figure 6. Typical Input Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation

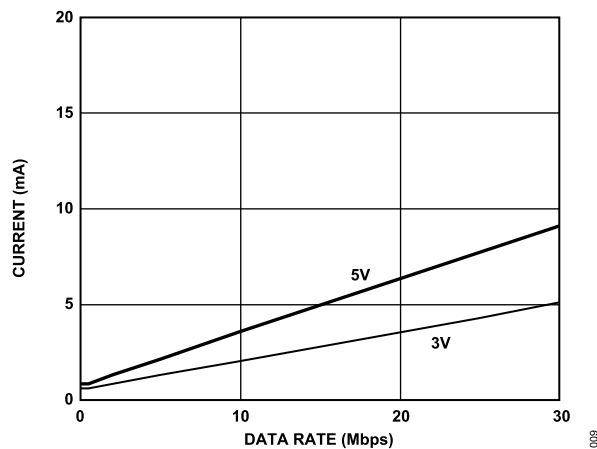


Figure 9. Typical ADuM3200 I_{DD1} Supply Current vs. Data Rate for 5 V and 3 V Operation

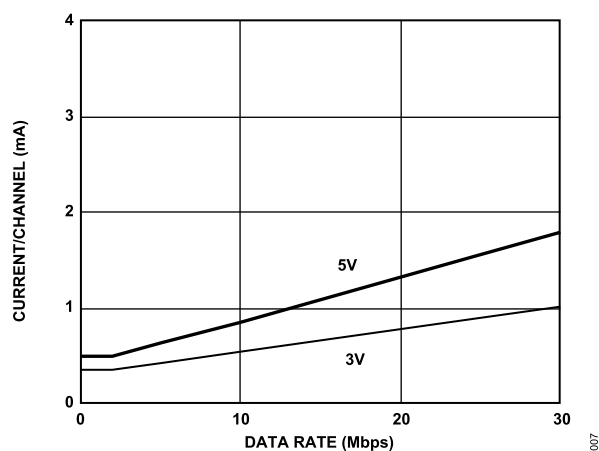


Figure 7. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (No Output Load)

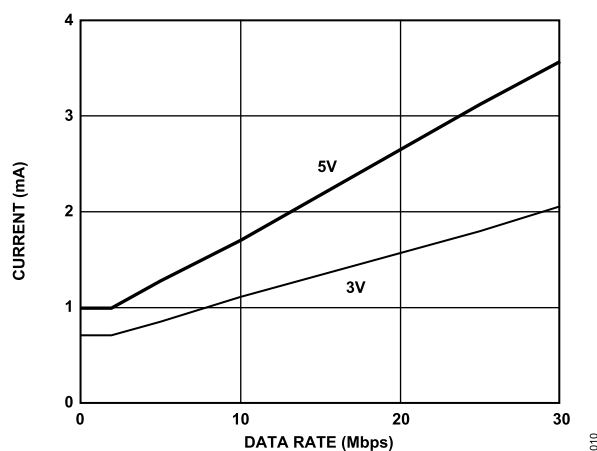


Figure 10. Typical ADuM3200 I_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

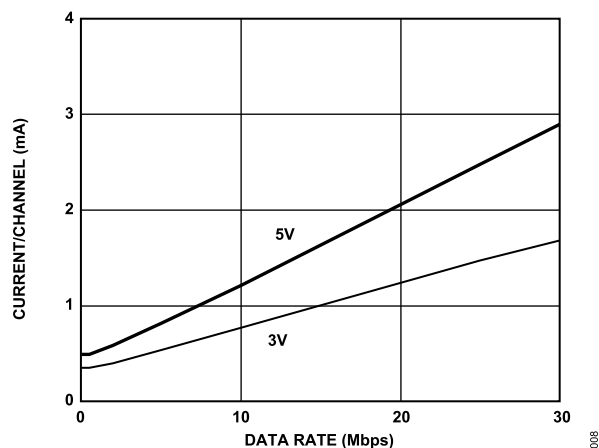


Figure 8. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (15 pF Output Load)

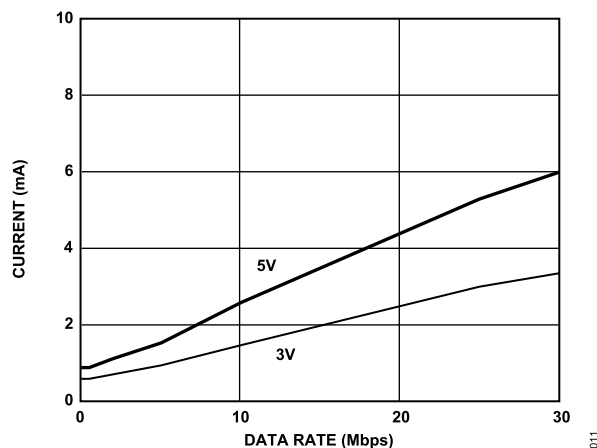


Figure 11. Typical ADuM3201 I_{DD1} or I_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

APPLICATION INFORMATION

PC BOARD LAYOUT

The ADuM3200/ADuM3201 digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins. The capacitor value must be between 0.01 μF and 0.1 μF . The total lead length between both ends of the capacitor and the input power supply pin must not exceed 20 mm. See the [AN-1109 Application Note](#) for board layout guidelines.

SYSTEM-LEVEL ESD CONSIDERATIONS AND ENHANCEMENTS

System-level ESD reliability (for example, per IEC 61000-4-x) is highly dependent on system design which varies widely by application. The ADuM3200/ADuM3201 incorporate many enhancements to make ESD reliability less dependent on system design. The enhancements include:

- ▶ ESD protection cells added to all input/output interfaces.
- ▶ Key metal trace resistances reduced using wider geometry and paralleling of lines with vias.
- ▶ The SCR effect inherent in CMOS devices minimized by use of guarding and isolation technique between PMOS and NMOS devices.
- ▶ Areas of high electric field concentration eliminated using 45° corners on metal traces.
- ▶ Supply pin overvoltage prevented with larger ESD clamps between each supply pin and the respective ground.

While the ADuM3200/ADuM3201 improve system-level ESD reliability, they are no substitute for a robust system-level design. See the [AN-793 Application Notes](#), *ESD/Latch-Up Considerations with iCoupler Isolation Product*, for detailed recommendations on board layout and system-level design.

PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the time it takes a logic signal to propagate through a component. The propagation delay to a logic low output can differ from the propagation delay to a logic high.

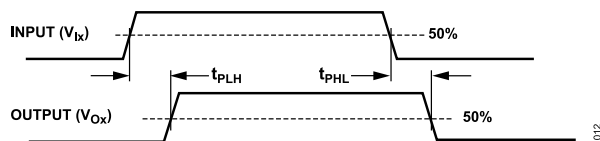


Figure 12. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the input signal timing is preserved.

Channel-to-channel matching refers to the maximum amount that the propagation delay differs between channels within a single ADuM3200/ADuM3201 component.

Propagation delay skew refers to the maximum amount that the propagation delay differs between multiple ADuM3200/ADuM3201 components operating under the same conditions.

DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow (~ 1 ns) pulses to be sent to the decoder via the transformer. The decoder is bistable and is therefore either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions of more than ~ 1 μs at the input, a periodic set of refresh pulses indicative of the correct input state are sent to ensure dc correctness at the output. If the decoder receives no internal pulses for more than about 5 μs , the input side is assumed to be unpowered or nonfunctional, in which case, the isolator output is forced to a default state (see [Table 32](#) and [Table 33](#)) by the watchdog timer circuit.

The ADuM3200/ADuM3201 are extremely immune to external magnetic fields. The limitation on the ADuM3200/ADuM3201 magnetic field immunity is set by the condition in which induced voltage in the transformer receiving coil is sufficiently large to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur. The 3 V operating condition of the ADuM3200/ADuM3201 is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than 1.0 V. The decoder has a sensing threshold at about 0.5 V, therefore establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta/dt) \sum \pi r_n^2, n = 1, 2, \dots, N \quad (1)$$

where:

β is the magnetic flux density (gauss).

N is the number of turns in the receiving coil.

r_n is the radius of the n th turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADuM3200/ADuM3201 and an imposed requirement that the induced voltage is at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated, as shown in [Figure 13](#).

APPLICATION INFORMATION

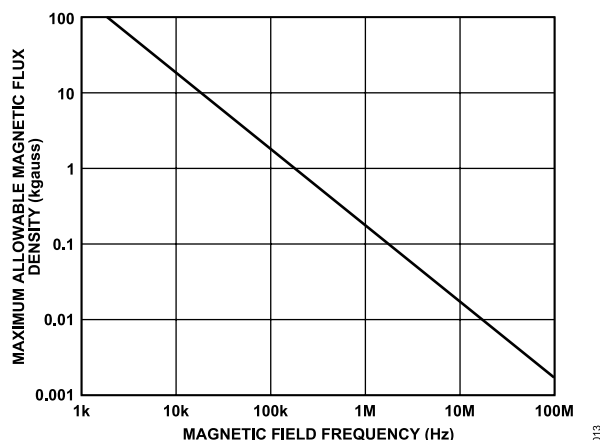


Figure 13. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event occurs during a transmitted pulse (and had the worst-case polarity), it reduces the received pulse from >1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM3200/ADuM3201 transformers. Figure 14 expresses these allowable current magnitudes as a function of frequency for selected distances. As seen, the ADuM3200/ADuM3201 are extremely immune and can be affected only by extremely large currents operated at high frequency and very close to the component. For the 1 MHz example, one must place a 0.5 kA current 5 mm away from the ADuM3200/ADuM3201 to affect the component operation.

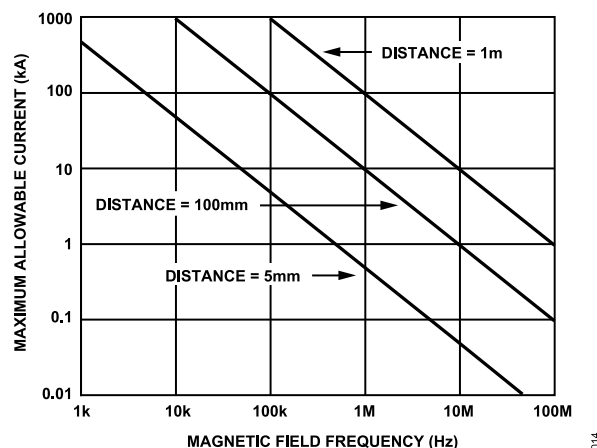


Figure 14. Maximum Allowable Current for Various Current-to-ADuM3200/ADuM3201 Spacings

Note that at combinations of strong magnetic fields and high frequencies, any loops formed by printed circuit board traces could induce sufficiently large error voltages to trigger the threshold of

succeeding circuitry. Care must be taken in the layout of such traces to avoid this possibility.

POWER CONSUMPTION

The supply current at a given channel of the ADuM3200/ADuM3201 isolator is a function of the supply voltage, the channel data rate, and the channel output load.

For each input channel, the supply current is given by

$$I_{DDI} = I_{DDI(Q)} \quad f \leq 0.5f_r \quad (2)$$

$$I_{DDI} = I_{DDI(D)} \times (2f - f_r) + I_{DDI(Q)} \quad f > 0.5f_r \quad (3)$$

For each output channel, the supply current is given by

$$I_{DDO} = I_{DDO(Q)} \quad f \leq 0.5f_r \quad (4)$$

$$I_{DDO} = (I_{DDO(D)} + (0.5 \times 10^{-3}) \times C_L V_{DDO}) \times (2f - f_r) + I_{DDO(Q)} \quad f > 0.5f_r \quad (5)$$

where:

$I_{DDI(D)}$, $I_{DDO(D)}$ are the input and output dynamic supply currents per channel (mA/Mbps).

C_L is the output load capacitance (pF).

V_{DDO} is the output supply voltage (V).

f is the input logic signal frequency (MHz, half of the input data rate, NRZ signaling).

f_r is the input stage refresh rate (Mbps).

$I_{DDI(Q)}$, $I_{DDO(Q)}$ are the specified input and output quiescent supply currents (mA).

To calculate the total I_{DD1} and I_{DD2} supply current, the supply currents for each input and output channel corresponding to I_{DD1} and I_{DD2} are calculated and totaled. Figure 6 provides per-channel input supply currents as a function of data rate.

Figure 7 and Figure 8 provide per-channel output supply currents as a function of data rate for an unloaded output condition and for a 15 pF output condition, respectively. Figure 9 through Figure 11 provide total I_{DD1} and I_{DD2} supply current as a function of data rate for ADuM3200 and ADuM3201 channel configurations.

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation depends upon the characteristics of the voltage waveform applied across the insulation. In addition to the testing performed by the regulatory agencies, Analog Devices carries out an extensive set of evaluations to determine the lifetime of the insulation structure within the ADuM3200/ADuM3201.

Analog Devices performs accelerated life testing using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined. These factors allow calculation of the time to failure at the actual working voltage.

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The values shown in [Table 31](#) summarize the maximum continuous working voltages as per IEC 60747-17. Operation at these high

working voltages can lead to shortened insulation life in some cases.

OUTLINE DIMENSIONS

Package Drawing (Option)	Package Type	Package Description
R-8	SOIC_N	8-Lead Standard Small Outline Package

For the latest package outline information and land patterns (footprints), go to [Package Index](#).

ORDERING GUIDE

Model ^{1, 2}	Temperature Range (°C)	Package Description	Packing Quantity	Package Option
ADuM3200ARZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200ARZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3200BRZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200BRZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3200CRZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200CRZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3200WARZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200WARZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3200WBRZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200WBRZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3200WCRZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3200WCRZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201ARZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201ARZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201BRZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201BRZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201CRZ	-40 to +105	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201CRZ-RL7	-40 to +105	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201WARZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201WARZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201WBRZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201WBRZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8
ADuM3201WCRZ	-40 to +125	8-Lead SOIC_N	Tube, 98	R-8
ADuM3201WCRZ-RL7	-40 to +125	8-Lead SOIC_N	Reel, 1000	R-8

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

NUMBER OF INPUTS, MAXIMUM DATA RATE, MAXIMUM PROPAGATION DELAY, AND MAXIMUM PULSE WIDTH DISTORTION OPTIONS

Model ¹	Number of Inputs, V _{DD1} Side	Number of Inputs, V _{DD2} Side	Maximum Data Rate (Mbps)	Maximum Propagation Delay, 5 V (ns)	Maximum Pulse Width Distortion (ns)
ADuM3200ARZ	2	0	1	150	40
ADuM3200ARZ-RL7	2	0	1	150	40
ADuM3200BRZ	2	0	10	50	3
ADuM3200BRZ-RL7	2	0	10	50	3
ADuM3200CRZ	2	0	25	45	3
ADuM3200CRZ-RL7	2	0	25	45	3
ADuM3200WARZ	2	0	1	150	40
ADuM3200WARZ-RL7	2	0	1	150	40
ADuM3200WBRZ	2	0	10	50	3
ADuM3200WBRZ-RL7	2	0	10	50	3

OUTLINE DIMENSIONS

Model ¹	Number of Inputs, V _{DD1} Side	Number of Inputs, V _{DD2} Side	Maximum Data Rate (Mbps)	Maximum Propagation Delay, 5 V (ns)	Maximum Pulse Width Distortion (ns)
ADuM3200WCRZ	2	0	25	45	3
ADuM3200WCRZ-RL7	2	0	25	45	3
ADuM3201ARZ	1	1	1	150	40
ADuM3201ARZ-RL7	1	1	1	150	40
ADuM3201BRZ	1	1	10	50	3
ADuM3201BRZ-RL7	1	1	10	50	3
ADuM3201CRZ	1	1	25	45	3
ADuM3201CRZ-RL7	1	1	25	45	3
ADuM3201WARZ	1	1	1	150	40
ADuM3201WARZ-RL7	1	1	1	150	40
ADuM3201WBRZ	1	1	10	50	3
ADuM3201WBRZ-RL7	1	1	10	50	3
ADuM3201WCRZ	1	1	25	45	3
ADuM3201WCRZ-RL7	1	1	25	45	3

¹ Z = RoHS Compliant Part.

AUTOMOTIVE PRODUCTS

The ADuM3200W/ADuM3201W models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the [Specifications](#) section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.